# Si4143DY

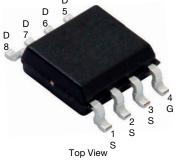
**Vishay Siliconix** 

www.vishay.com

### P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (TYP.)			
	0.0062 at V <sub>GS</sub> = -10 V	-25.3				
-30	0.0074 at V <sub>GS</sub> = -6 V	-23.2	54 nC			
	0.0092 at V <sub>GS</sub> = -4.5 V	-20.8				

### SO-8 Single

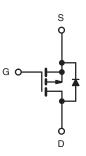


### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Adaptor switch, load switch
- Power management
- Notebook computers



P-Channel MOSFET

Ordering Information: Si4143DY-T1-GE3 (lead (Pb)-free and halogen-free)

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	-30	V		
Gate-Source Voltage		V <sub>GS</sub>			± 25
	T <sub>C</sub> = 25 °C		-25.3		
Constitutions Durate Ocument (T. 150 °C)	T <sub>C</sub> = 70 °C		-20.2		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-17.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		-14.1 <sup>a, b</sup>		
Pulsed Drain Current (t = 300 µs)	I <sub>DM</sub>	-70	— A		
Continuous Courses Dusis Diada Courset	T <sub>C</sub> = 25 °C		-5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-2.4 <sup>a, b</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-30		
Single Pulse Avalanche Energy	E <sub>AS</sub>	45	mJ		
	T <sub>C</sub> = 25 °C		6		
Maximum Davier Diasia atian	T <sub>C</sub> = 70 °C		3.8	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.9 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		1.9 <sup>a, b</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>sta</sub>	-55 to 150	°C		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum Junction-to-Ambient a, c	t ≤ 10 s	R <sub>thJA</sub>	36	43	°C/W		
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	16	21	C/W		

#### Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 84 °C/W.

d. Based on  $T_C = 25$  °C.

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Pb-free RoHS

COMPLIANT

HALOGEN

FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	-30	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	L 050 A	-	-23	-		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.9	-	mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-	-2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30	-	-	Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -12 A			0.0062		
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = -6 V, I <sub>D</sub> = -8 A	-	0.0061	0.0074	Ω	
	-(- /	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -5 A	-	0.0076	0.0092	1	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -15 A	-	64	-	S	
Dynamic <sup>b</sup>							
Input Capacitance	Ciss		-	6630	-	pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	750	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	710	-		
Total Gate Charge	Qg	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -18 \text{ A}$	-	111	167		
		V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -18 A	-	54	81	nC	
Gate-Source Charge	Q <sub>gs</sub>		-	19.5	-		
Gate-Drain Charge	Q <sub>qd</sub>		-	15.5	-		
Gate Resistance	R <sub>a</sub>	f = 1 MHz	0.5	2.3	4.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>		-	18	27	- ns	
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	8	16		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -10$ A, $V_{GEN} = -10$ V, $R_g = 1 \Omega$	-	71	107		
Fall Time	t <sub>f</sub>		-	15	23		
Turn-On Delay Time	t <sub>d(on)</sub>		-	59	89		
Rise Time	tr	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	60	90		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	56	84		
Fall Time	t <sub>f</sub>		-	29	44		
Drain-Source Body Diode Characterist	ics			1	<u> </u>	<u> </u>	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-5		
Pulse Diode Forward Current	I <sub>SM</sub>		-	-	-70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = -10 A, V <sub>GS</sub> = 0 V	-	-0.78	-1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>		-	42	63	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			37	56	nC	
Reverse Recovery Fall Time	ta	l <sub>F</sub> = -10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C -	-	17	-	ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1	-	25	-		

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

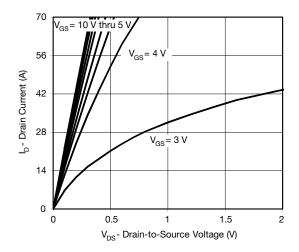
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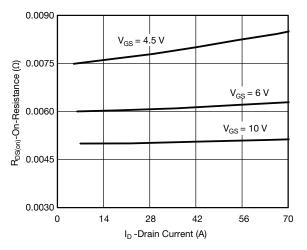


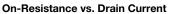
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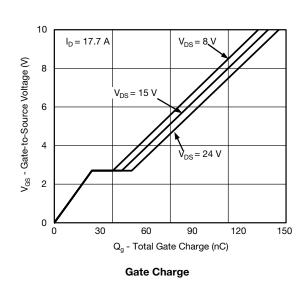
### **TYPICAL CHARACTERISTICS** (T<sub>J</sub> = 25 °C, unless otherwise noted)

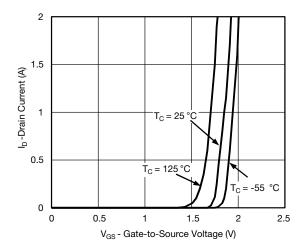


**Output Characteristics** 

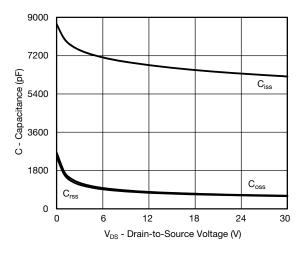




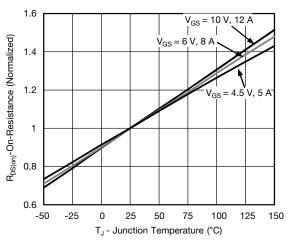




**Transfer Characteristics** 







#### On-Resistance vs. Junction Temperature

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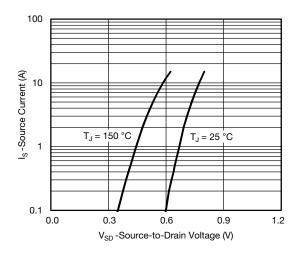
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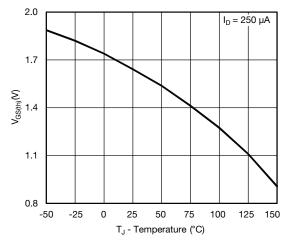
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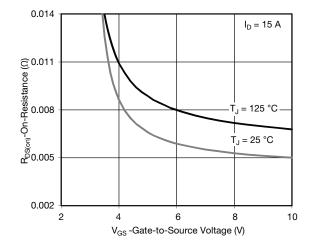
### **TYPICAL CHARACTERISTICS** ( $T_J = 25 \text{ °C}$ , unless otherwise noted)



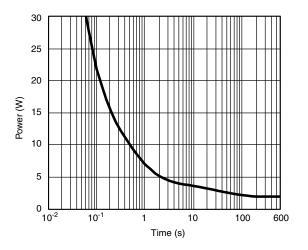
Source-Drain Diode Forward Voltage



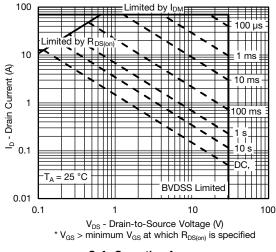




**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient

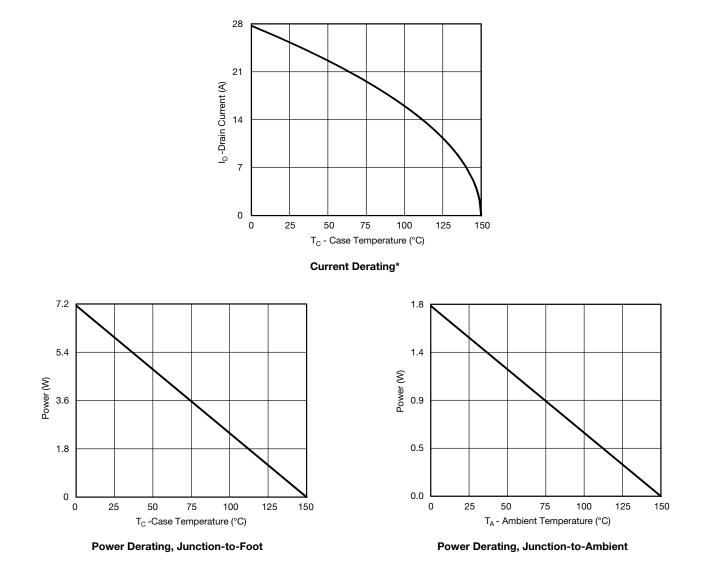


Safe Operating Area

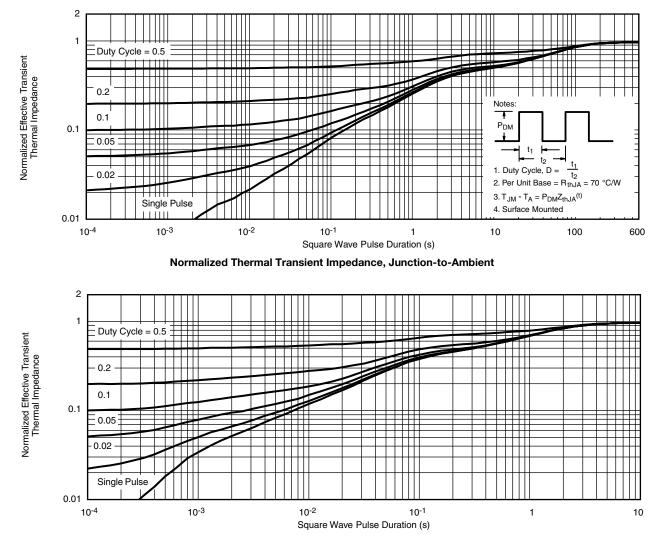


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#### **TYPICAL CHARACTERISTICS** (T<sub>J</sub> = 25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J (max.)} = 150 \text{ °C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63242.

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### TYPICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, unless otherwise noted)

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# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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